Server & Storage I/O Connector

DDR5 288pin SMT Connector



OVERVIEW

Luxshare-TECH's vertical DDR5 DIMM sockets provide 288 contacts on 0.85mm pitch. The DDR5 connector interface could be mated with the DDR5 memory modules that conform to JEDEC MO-329. The DDR5 family support SMT solder types. Luxshare-TECH DDR5 connectors could support multi-form of DDR5 modules including UDIMM, RDIMM and LRDIMM. Based on excellent performance and diverse options, Luxshare DDR5 product family are widely adopted in PCs, servers, workstations, storage, and embedded applications in communications and industrial equipment.

FEATURES & BENEFITS

- Supporting channels with transfer rates up to 6.4 GT/S
- Different color for housing and ejector can meet various need
- Lower insertion force, easier for module insertion and enough retention force for better reliability
- Narrow housing solutions, Saves board space and benefits air-flow

PRODUCT APPLICATIONS

Data center & Networking Equipment Servers/Storage Devices High Performance Computing (HPC) Switches/Routers

INDUSTRY STANDARDS

SMT: JEDEC Socket Outlines: SO-023

TECHNICAL INFORMATION

MATERIAL

Terminal: Copper Alloy Contact Area Finish: Gold over Nickel Solder Area Finish: Tin over Nickel Board lock: Stainless steel, plated tin over nickel Housing: High temperature thermoplastic(UL 94V-0) Latch: High temperature thermoplastic(UL 94V-0)

ELECTRICAL PERFORMANCE

Voltage: 30V AC(RMS)/DC Current: 1A MAX per contact Reference impedance = 50ohm

ENVIRONMENTAL

Operating temperature : -55°C TO +85°C Storage temperature : +15°C TO +35°C Relative humidity: 20% to 80% Atmospheric pressure: 650mm to 800mm of Hg (86 ~106Kpa)

Partial PN Table

| Product Numbers | Product Description |
|--------------------|-------------------------|
| PD5288-351T-BBN-3H | DDR5 SMT OPEN157,HSG: |
| PD5288-350H-BB2-3H | DDR5 SMT OPEN157,HSG:BF |
| | |



MECHANICAL PERFORMANCE

Rated Durability Cycles: 25 Mating Force: 0.37N /pin MAX Unmating Force: 0.07N /pin MIN Retention force- Terminal: 300gf/pin MIN Retention force- Board lock: 13.3N /pin MIN Insertion force - Connector to board: 7.65kgf MAX Preheat: +150° to +180°C / 60~120 seconds Reflow: +230° to +260°C / 30~60 seconds

PACKAGING

Tray

SPECIFICATION

ES-11-00-0003

B:BK,Latch:BK,3TAB

3K,Latch:BK,3HOOK